

**Amendments to the Claims:**

The following listing of claims will replace all prior versions, and listings, of claims in the application:

1. (Currently Amended) An exposure apparatus which exposes a substrate by radiating an exposure light beam onto the substrate through a liquid, the exposure apparatus comprising:

a supply inlet from which the liquid is supplied, the liquid supplied from the supply inlet covering only a portion of an upper surface of the substrate during exposure;

a substrate stage ~~which has~~having a substrate-holding member ~~for holding~~by which the substrate is held, and ~~which is movable~~; the substrate-holding member holding the substrate on an underside of the substrate and the substrate-holding member being movable below the supply inlet; and

a temperature adjustment system which performs temperature adjustment for the substrate-holding member depending on a temperature of the liquid to be supplied from the supply inlet onto the substrate held by the substrate-holding member.

2. (Original) The exposure apparatus according to claim 1, wherein the temperature adjustment system performs the temperature adjustment for the substrate-holding member so that heat transfer is reduced between the substrate and the liquid on the substrate.

3. (Original) The exposure apparatus according to claim 1, wherein the temperature adjustment system performs the temperature adjustment for the substrate-holding member so that no temperature change of the liquid is caused by contact between the liquid and the substrate.

4. (Original) The exposure apparatus according to claim 3, wherein the temperature adjustment system performs the temperature adjustment for the substrate-holding member so that no temperature distribution is generated in the liquid.

5. (Original) The exposure apparatus according to claim 3, further comprising a surface position-detecting unit which detects surface position information about a surface of the substrate by emitting a detecting light beam onto the substrate through the liquid and receiving a reflected light beam from the substrate through the liquid, wherein the temperature adjustment system performs the temperature adjustment for the substrate-holding member to suppress measurement error of the surface position-detecting unit due to the temperature change of the liquid.

6. (Original) The exposure apparatus according to claim 1, wherein the temperature adjustment system performs the temperature adjustment for the substrate-holding member so that no temperature change of the substrate is caused by contact between the liquid and the substrate.

7. (Previously Presented) The exposure apparatus according to claim 6, further comprising a mark-detecting system which detects an alignment mark on the substrate not through the liquid, wherein the temperature adjustment system performs the temperature adjustment for the substrate-holding member so that no temperature change of the substrate is caused by the contact between the liquid and the substrate after detecting the mark by the mark-detecting system.

8. (Currently Amended) The exposure apparatus according to claim 1, wherein the temperature adjustment system uses a liquid which is the same as the liquid to be supplied onto the substrate to perform the temperature adjustment for the substrate-holding member.

9. (Canceled)

10. (Original) The exposure apparatus according to claim 1, further comprising a temperature sensor which measures a temperature of the substrate-holding member.

11-29. (Canceled)

30. (Currently Amended) An exposure apparatus which exposes a first or a second substrate by radiating an exposure light beam onto the first or second substrate through a liquid, the exposure apparatus comprising:

a liquid supply system having a supply inlet from which the liquid is supplied;

a first substrate stage ~~which has~~ having a first substrate-holding member ~~for holding the~~ by which the first substrate and which is movable; is held, the first substrate-holding member holding the first substrate on an underside of the first substrate and the first substrate-holding member being movable below the supply inlet;

a second substrate stage ~~which has~~ having a second substrate-holding member ~~for holding the~~ by which the second substrate and which is movable; is held, the second substrate-holding member holding the second substrate on an underside of the second substrate and the second substrate-holding member being movable below the supply inlet;

a measuring station which performs measurement for one of the substrate substrates held by one of the stages;

an exposure station which performs exposure for the substrate held by the other of the stages, the exposure station being provided with ~~a~~ the liquid supply system which supplies the liquid onto the ~~substrate;~~ substrate held by the other of the stages, the supplied liquid covering only a portion of an upper surface of the substrate held by the other of the stages during the exposure; and

temperature adjustment systems which are provided for the first substrate stage and the second substrate stage respectively and which perform temperature adjustment for the substrate-holding member of each of the stages depending on a temperature of the liquid to be supplied from the liquid supply system.

31. (Original) The exposure apparatus according to claim 30, wherein the measurement for the substrate in the measuring station includes measurement of surface position information about a surface of the substrate.

32. (Original) The exposure apparatus according to claim 30, wherein the measurement for the substrate in the measuring station includes detection of an alignment mark on the substrate.

33. (Currently Amended) The exposure apparatus according to claim 30, wherein the temperature adjustment system performs the temperature adjustment for the first substrate-holding member before performing the measurement for the ~~substrate~~ first substrate and performs the temperature adjustment for the second substrate-holding member before performing the measurement for the second substrate.

34. (Canceled)

35. (Currently Amended) The exposure apparatus according to claim 30, wherein the temperature adjustment system performs, after the measurement for the substrate in the measuring station, the temperature adjustment for the respective substrate-holding member to suppress temperature change of the ~~substrate~~ substrate in the measuring station.

36-43. (Canceled)

44. (Previously Presented) A method for producing a device, comprising:  
exposing a substrate using the exposure apparatus as defined in claim 1; and  
processing the exposed substrate.

45-64. (Canceled)

65. (Currently Amended) The exposure apparatus according to claim 30, further comprising a projection optical system which projects an image of a pattern through the liquid onto the substrate ~~through the liquid being exposed~~ wherein the exposure station is provided with the projection optical system.

66-67. (Canceled)

68. (Previously Presented) A method for producing a device, comprising:  
exposing a substrate using the exposure apparatus as defined in claim 30; and  
processing the exposed substrate.

69. (Canceled)

70. (Previously Presented) The exposure apparatus according to claim 1, wherein  
the temperature adjustment system performs the temperature adjustment for the substrate-  
holding member so that the temperature of the substrate-holding member is the same as the  
temperature of the liquid to be supplied onto the substrate held by the substrate-holding  
member.

71. (Previously Presented) The exposure apparatus according to claim 1, wherein  
the temperature adjustment system performs the temperature adjustment for the substrate-  
holding member so that no deformation of the substrate is caused by contact between the liquid  
and the substrate.

72. (Currently Amended) The exposure apparatus according to claim 10, wherein  
the temperature adjustment system performs the temperature ~~adjust~~adjustment for the substrate-  
holding member so that the measured temperature of the substrate-holding member is the same  
as the temperature of the liquid to be supplied onto the substrate held by the substrate-holding  
member.

73. (Canceled)

74. (Currently Amended) An exposure method comprising:  
holding a substrate by a substrate-holding ~~member~~member on an underside of  
the substrate;

supplying a liquid from a supply inlet onto an upper surface of the substrate held by the substrate-holding member so that the supplied liquid covers only a portion of ~~a~~ the upper surface of the substrate held by the substrate-holding member;

controlling a temperature of the substrate-holding member depending on a temperature of the liquid to be supplied onto the substrate held by the substrate-holding member; ~~and~~

moving the substrate below the supply inlet; and

exposing the substrate by radiating an exposure light beam onto the substrate through the supplied liquid.

75. (Previously Presented) The exposure method according to claim 74, wherein the temperature of the substrate-holding member is controlled so that heat transfer between the substrate and the supplied liquid is prevented.

76. (Previously Presented) The exposure method according to claim 74, wherein the temperature of the substrate-holding member is controlled so that temperature change of the liquid on the substrate is prevented.

77. (Previously Presented) The exposure method according to claim 74, wherein the temperature of the substrate-holding member is controlled so that temperature change of the substrate due to contact between the supplied liquid and the substrate is prevented.

78. (Previously Presented) The exposure method according to claim 77, further comprising detecting an alignment mark on the substrate held by the substrate-holding member not through the liquid, wherein the temperature of the substrate-holding member is controlled so that the temperature change of the substrate caused after detecting the mark is prevented.

79. (Currently Amended) The exposure method according to claim 74, wherein the temperature of the substrate-holding member is controlled using a liquid which is the same as the liquid to be supplied onto the substrate.



80. (Previously Presented) The exposure method according to claim 79, wherein the temperature of the substrate-holding member is controlled by flowing the liquid in the substrate-holding member.

81. (Previously Presented) The exposure method according to claim 74, further comprising measuring the temperature of the substrate-holding member, wherein the temperature of the substrate-holding member is controlled so that the measured temperature of the substrate-holding member is the same as the temperature of the liquid to be supplied onto the substrate held by the substrate-holding member.

82. (Previously Presented) The exposure method according to claim 74, wherein the temperature of the substrate-holding member is controlled so that the temperature of the substrate-holding member is the same as the temperature of the liquid to be supplied onto the substrate held by the substrate-holding member.

83. (Previously Presented) The exposure method according to claim 74, wherein the temperature of the substrate-holding member is controlled so that deformation of the substrate due to contact between the supplied liquid and the substrate is prevented.

84. (New) An exposure apparatus which exposes a substrate by radiating an exposure light beam onto the substrate through a liquid, the exposure apparatus comprising:

a supply inlet from which the liquid is supplied, the liquid supplied from the supply inlet covering only a portion of an upper surface of the substrate during exposure;

a substrate stage having a substrate-holding member by which the substrate is held, the substrate holding member holding the substrate on an underside of the substrate and the substrate-holding member being movable below the supply inlet; and

a temperature adjustment system which performs temperature adjustment for the substrate-holding member so that a temperature of the substrate-holding member is the same as

a temperature of the liquid to be supplied onto the substrate held by the substrate-holding member.

85. (New) The exposure apparatus according to claim 84, wherein the temperature adjustment system performs the temperature adjustment for the substrate-holding member so that heat transfer is reduced between the substrate and the liquid on the substrate.

86. (New) The exposure apparatus according to claim 84, wherein the temperature adjustment system performs the temperature adjustment for the substrate-holding member so that no temperature change of the liquid is caused by contact between the liquid and the substrate.

87. (New) The exposure apparatus according to claim 86, wherein the temperature adjustment system performs the temperature adjustment for the substrate-holding member so that no temperature distribution is generated in the liquid.

88. (New) The exposure apparatus according to claim 86, further comprising a surface position-detecting unit which detects surface position information about a surface of the substrate by emitting a detecting light beam onto the substrate through the liquid and receiving a reflected light beam from the substrate through the liquid, wherein the temperature adjustment system performs the temperature adjustment for the substrate-holding member to suppress measurement error of the surface position-detecting unit due to the temperature change of the liquid.

89. (New) The exposure apparatus according to claim 84, wherein the temperature adjustment system performs the temperature adjustment for the substrate-holding member so that no temperature change of the substrate is caused by contact between the liquid and the substrate.

90. (New) The exposure apparatus according to claim 89, further comprising a mark-detecting system which detects an alignment mark on the substrate not through the



liquid, wherein the temperature adjustment system performs the temperature adjustment for the substrate-holding member so that no temperature change of the substrate is caused by the contact between the liquid and the substrate after detecting the mark by the mark-detecting system.

91. (New) The exposure apparatus according to claim 84, wherein the temperature adjustment system uses a liquid which is the same as the liquid to be supplied onto the substrate to perform the temperature adjustment for the substrate-holding member.

92. (New) The exposure apparatus according to claim 84, further comprising a temperature sensor which measures a temperature of the substrate-holding member.

93. (New) The exposure apparatus according to claim 92, wherein the temperature adjustment system performs the temperature adjustment for the substrate-holding member so that the measured temperature of the substrate-holding member is the same as the temperature of the liquid to be supplied onto the substrate held by the substrate-holding member.